

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE60P82AD uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is well suited for high current load applications.

General Features

V_{DS} =-60V,I_D =-82A

 $R_{DS(ON)}$ <13m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ <16m Ω @ V_{GS} =-4.5V

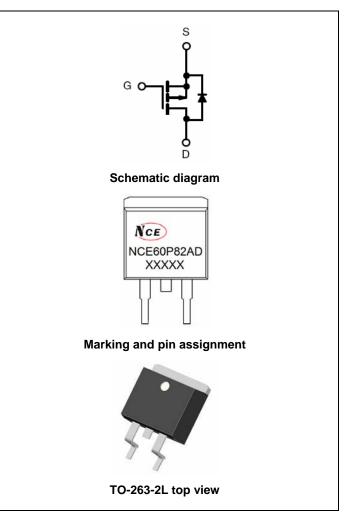
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

Load switch

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Thermal Resistance, Junction-to-Case (Note 2)

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60P82AD	NCE60P82AD	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	-60	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	I _D	-82	А	
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	-58	Α	
Pulsed Drain Current	I _{DM}	-328	А	
Maximum Power Dissipation	P _D	150	W	
Derating factor		1.0	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	722	mJ	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}\!$	

 $R_{\theta JC}$

1.0

°C/W

Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	-1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.2	-1.8	-2.4	V
Drain-Source On-State Resistance	В	V _{GS} =-10V, I _D =-20A	-	11	13	mΩ
Dialii-Source Oil-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-20A	-	13	16	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-20A	-	25	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	V _{DS} =-30V,V _{GS} =0V, F=1.0MHz	-	5604	-	PF
Output Capacitance	Coss		-	356	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0WHZ	-	265	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}	V_{DD} =-30V, R_{L} =1.5 Ω , V_{GS} =-10V, R_{G} =3 Ω	-	18	-	nS
Turn-on Rise Time	t _r		-	20	-	nS
Turn-Off Delay Time	t _{d(off)}		-	55	-	nS
Turn-Off Fall Time	t _f		-	35	-	nS
Total Gate Charge	Qg	- V _{DS} =-30,I _D =-20A, - V _{GS} =-10V	-	62.1		nC
Gate-Source Charge	Q _{gs}		-	9.3		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	16.8		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-82	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, I _F =-20A	-	49		nS
Reverse Recovery Charge	Qrr	di/dt = -100A/µs ^(Note3)	-	71		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

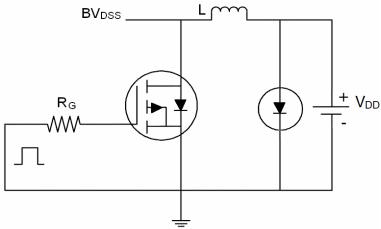
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25 $^{\circ}\!\!\mathrm{C}$,V_{DD}=-30V,V_G=-10V,L=0.5mH,Rg=25 Ω

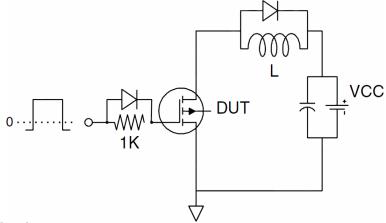


Test Circuit

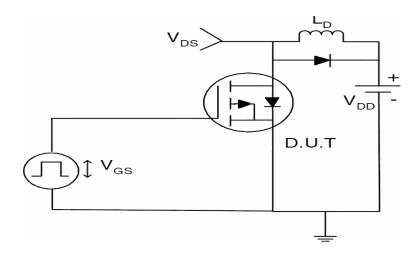
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

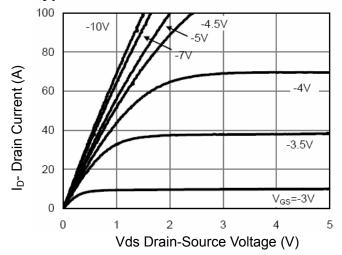


Figure 1 Output Characteristics

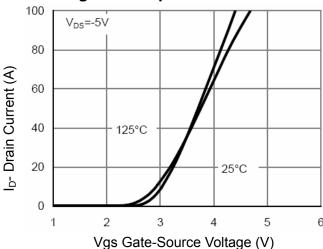


Figure 2 Transfer Characteristics

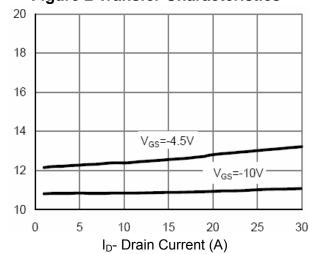


Figure 3 Rdson- Drain Current

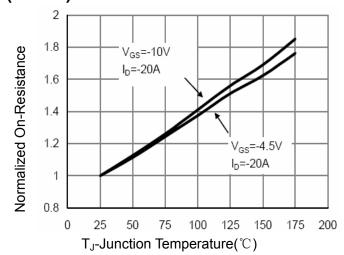


Figure 4 Rdson-Junction Temperature

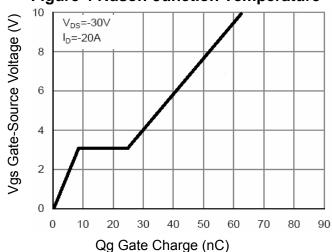


Figure 5 Gate Charge

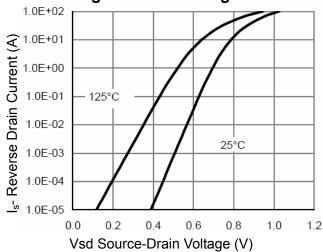


Figure 6 Source- Drain Diode Forward



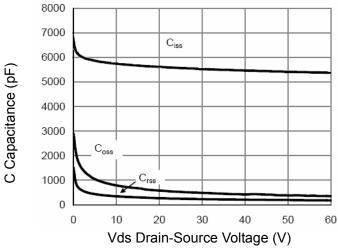


Figure 7 Capacitance vs Vds

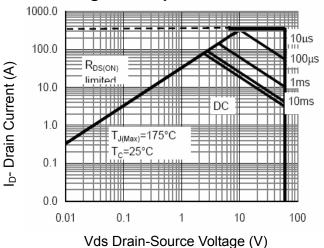


Figure 8 Safe Operation Area

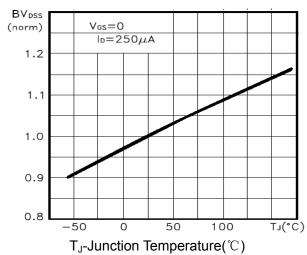


Figure 9 BV_{DSS} vs Junction Temperature

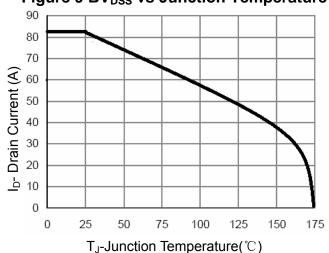


Figure 10 ID Current Derating vs Junction Temperature

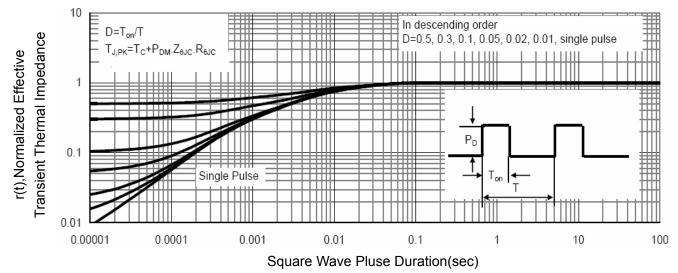
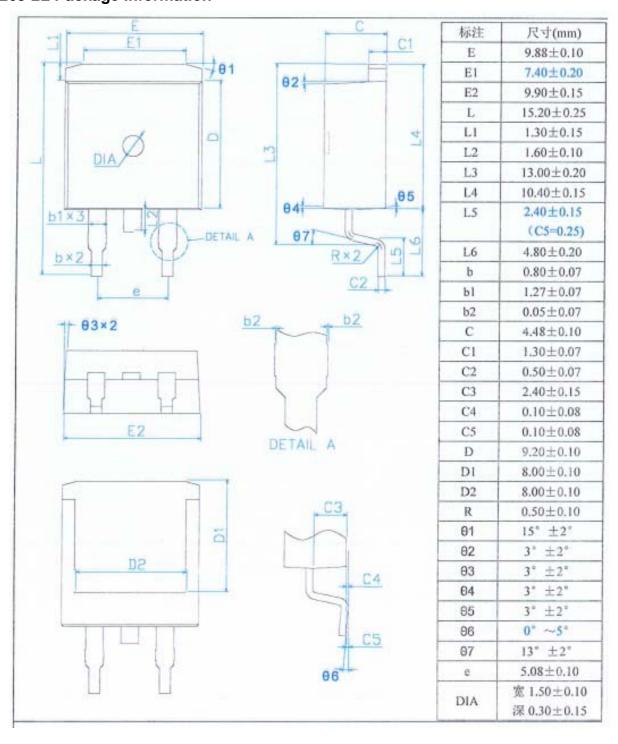


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-263-2L Package Information





http://www.ncepower.com

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